### Guangdong Yongyu Optoelectronics Co., Ltd





#### ChipLED 0603 Series 1.6\*0.8\*0.6mm Single Color Package



A representative image

**ChipLED 0603 Green Series** 

# Description

- These ChipLEDs are designed in an industry-standard package.
- Various LED colors are available in seven compact, single-color packages.
- The YY0603 has the industry-standard 1.6 mm  $\times$  0.8 mm footprint, which is excellent for all-around use.
- These ChipLEDs are packaged in tape and reel with 4000 units in general per reel.
- All packages are compatible with IR reflow solder processes.
- The small size and wide viewing angle,

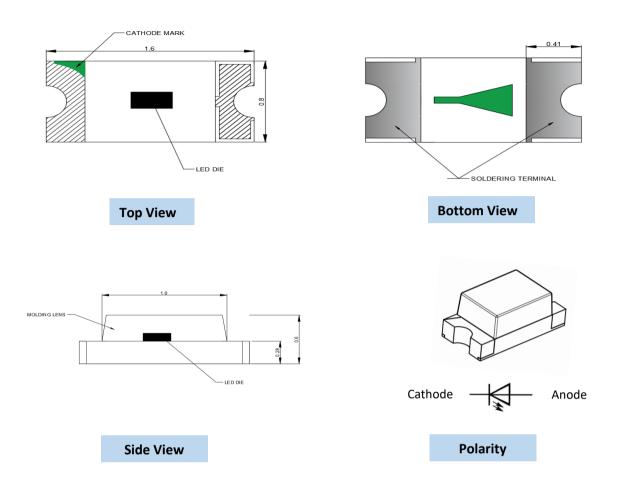
# **Features and Benefits**

- Small size, Industry-standard footprint
- Compatible with Infrared solder process
  Compatible with automatic placement
  equipment
- Operating temperature range of -40°C to +85°C
- Viewing angle: 140°
- Right angle and reverse mount package available
- Various colors available
- Available in 8-mm tape, 7" reel (4000 pcs/reel), Meets EIA STD package
- Moisture sensitivity level: 3
- Halogen-free , RoHS and REACH compliant

# **Applications**

- Keypad backlighting
- Push-button and switch backlighting
- LCD backlighting
- Symbol backlighting
- Front-panel indicator
- Optical indicator
- Home and smart appliances
- Wearable and portable devices
- Toys
- Displays for industrial control systems

# Package Drawing



### Note:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.1 mm unless otherwise specified.

Par	Part Table								
#	Part Number	Emission Color	Polarity	Znener	Binning Current (mA)	Luminous Intensity (mcd)	Dominant Wavelength (nm)	Forward Voltage (V)	Remark
1	YY0603GR-NN1S0-T2AR4	Green			5	175-360	519-534	2.5-3.0	
2	YY0603GR-NZ1S0-T2AR4	Green		available	5	210-430	519-531	2.8-3.3	
3	YY0603GR-NN1S2-T2AR4	Green			5	300-620	522-534	2.3-2.7	High Brightness
4	YY0603GR-NN3S0-T2AR4	Green			20	520-1100	516-531	2.6-3.4	
5	YY0603GR-NN3S2-T2AR4	Green			20	900-1900	519-528	2.7-3.3	High Brightness

# Absolute Maximum Ratings for at Ta = 25°C

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V <sub>R</sub>	5	V	
Forward Current	I <sub>F</sub>	20	mA	
Peak Forward Current(Duty 1/10 @1KHz)	I <sub>FP</sub>	60	mA	
Power Dissipation	Pd	70	mW	
Electrostatic Discharge	ESD <sub>HBM</sub>	2000	V	
Operating Temperature	Topr	-40 ~ +85	C°	
Storage Temperature	Tstg	-40 ~ +85	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec.		
	1301	Hand Soldering : 300 °C for 3 sec.		

#### Luminous Intensity (Iv) Bin Limits

Bin ID	Luminous Intensity(mcd)			
	Min.	Max.		
P23	175	210		
P24	210	250		
P25	250	300		
P26	300	360		
P27	360	430		
P28	430	520		
P29	520	620		
P30	620	750		
P31	750	900		
P32	900	1100		
P33	1100	1350		
P34	1350	1600		
P35	1600	1900		

Forward Voltalge(V) Bin Limits

Bin ID	Forward Voltage(V)			
	Min.	Max.		
VJ	2.3	2.4		
VK	2.4	2.5		
VL	2.5	2.6		
VM	2.6	2.7		
VN	2.7	2.8		
VO	2.8	2.9		
VP	2.9	3.0		
VQ	3.0	3.1		
VR	3.1	3.2		
VS	3.2	3.3		
VT	3.3	3.4		

#### Dominant Wavelength (nm) Bin Limits

Bin ID	Dominant Wavelength (nm)			
BIITID	Min.	Max.		
G3	516	519		
G4	519	522		
G5	522	525		
G6	525	528		
G7	528	531		
G8	531	534		

\* Tolerance of measurement of luminous intensity is ±10%.

\* Tolerance of measurement of forward voltage is ±0.05V.

\* Tolerance of measurement of dominant wavelength is  $\pm 1$  nm.

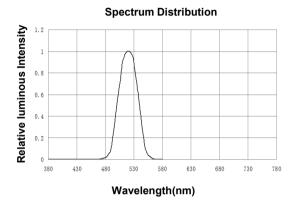
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### 0603 Green Series

#### Surface Mount ChipLEDs

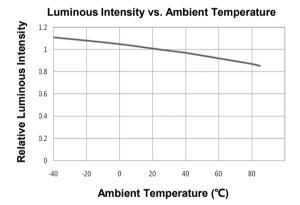
## TYPICAL ELECTRO-OPTICAL CHARATERISTICS CURES(Ta=25°C)

The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

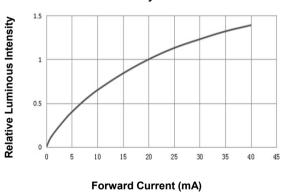


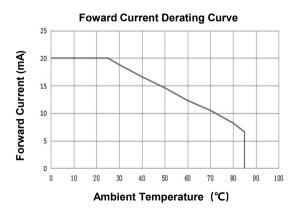
45 Forward Current (mA) 40 35 30 25 20 15 10 5 0 2.8 3.4 3.6 2.4 2.6 3. 2 3.8 2.2 3 Forward Volage (V)

Forward Current vs. Foward Voltage

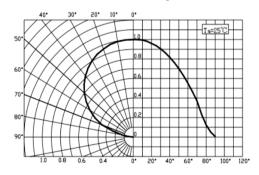


Luminous Intensity vs. Forward Current





**Radiation Diagram** 

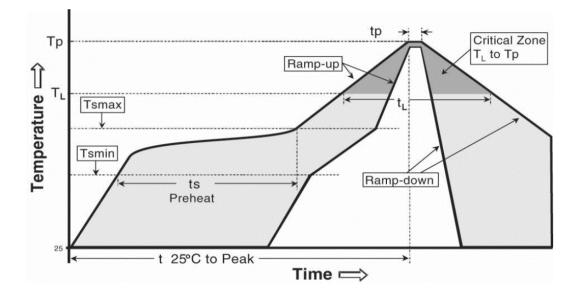


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### 0603 Green Series

## **REFLOW SOLDERING**

- The ChipLED is rated as a MSL3 as general request product.
- The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



	IPC/JEDEC J-STD-020C
Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Ts <sub>min</sub> )	<b>150°</b> ℃
- Temperature Max(Ts <sub>max</sub> )	200°C
- Time(Tsmin to Ts <sub>max</sub> )	60-180 seconds
Time mainted above	
- Temperature(T <sub>L</sub> )	217°C
- Time(T <sub>L</sub> )	60-150 seconds
Peak Temperature(Tp)	<b>260°</b> ℃
Time within 5°C of actual peak Temperature(tp) <sup>2</sup>	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.

### **Moisture Sensitivity**

• Yongyu recommends keeping ChipLEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain ChipLEDs do not need special storage for moisture sensitivity.

• Once the MBP is opened, ChipLEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of  $\leq$  30 °C/60% relative humidity (RH). Regardless of the storage condition, Yongyu LED recommends sealing any unsoldered ChipLEDs in the original MBP.

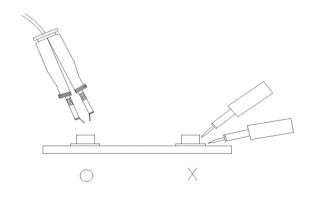
#### Handling

The packaging sizes of these SMD products are very small. Users are required to handle with care.

• To avoid damaging the product's surface and interior device, it is recommended to choose a special nozzle to pick up the SMD products during the process of SMT production. If handling is necessary, take special care when picking up these products.

### Repairing

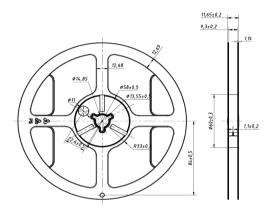
Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be

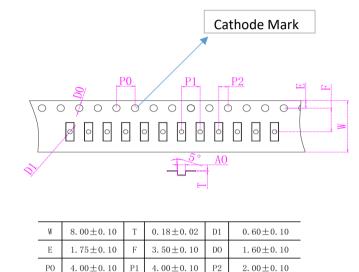


## 0603 Green Series

# PACKING

- The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- The reel pack is applied in SMD LED.
- 4000pcs per reel.





 $1.83 \pm 0.10$ 

KO

 $0.76 \pm 0.10$ 



AO

 $0.95 \pm 0.10$ 

BO

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